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Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

| | |
|---------------------------------|---|
| Product Status | Obsolete |
| Programmable Type | In System Programmable |
| Delay Time tpd(1) Max | 7.5 ns |
| Voltage Supply - Internal | 4.75V ~ 5.25V |
| Number of Logic Elements/Blocks | 8 |
| Number of Macrocells | 128 |
| Number of Gates | 2500 |
| Number of I/O | 84 |
| Operating Temperature | 0°C ~ 70°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 100-BQFP |
| Supplier Device Package | 100-PQFP (20x14) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/epm7128sqc100-7f |

MAX 7000 devices contain from 32 to 256 macrocells that are combined into groups of 16 macrocells, called logic array blocks (LABs). Each macrocell has a programmable-AND/fixed-OR array and a configurable register with independently programmable clock, clock enable, clear, and preset functions. To build complex logic functions, each macrocell can be supplemented with both shareable expander product terms and high-speed parallel expander product terms to provide up to 32 product terms per macrocell.

The MAX 7000 family provides programmable speed/power optimization. Speed-critical portions of a design can run at high speed/full power, while the remaining portions run at reduced speed/low power. This speed/power optimization feature enables the designer to configure one or more macrocells to operate at 50% or lower power while adding only a nominal timing delay. MAX 7000E and MAX 7000S devices also provide an option that reduces the slew rate of the output buffers, minimizing noise transients when non-speed-critical signals are switching. The output drivers of all MAX 7000 devices (except 44-pin devices) can be set for either 3.3-V or 5.0-V operation, allowing MAX 7000 devices to be used in mixed-voltage systems.

The MAX 7000 family is supported by Altera development systems, which are integrated packages that offer schematic, text—including VHDL, Verilog HDL, and the Altera Hardware Description Language (AHDL)—and waveform design entry, compilation and logic synthesis, simulation and timing analysis, and device programming. The software provides EDIF 2.0.0 and 3.0.0, LPM, VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industry-standard PC- and UNIX-workstation-based EDA tools. The software runs on Windows-based PCs, as well as Sun SPARCstation, and HP 9000 Series 700/800 workstations.



For more information on development tools, see the *MAX+PLUS II Programmable Logic Development System & Software Data Sheet* and the *Quartus Programmable Logic Development System & Software Data Sheet*.

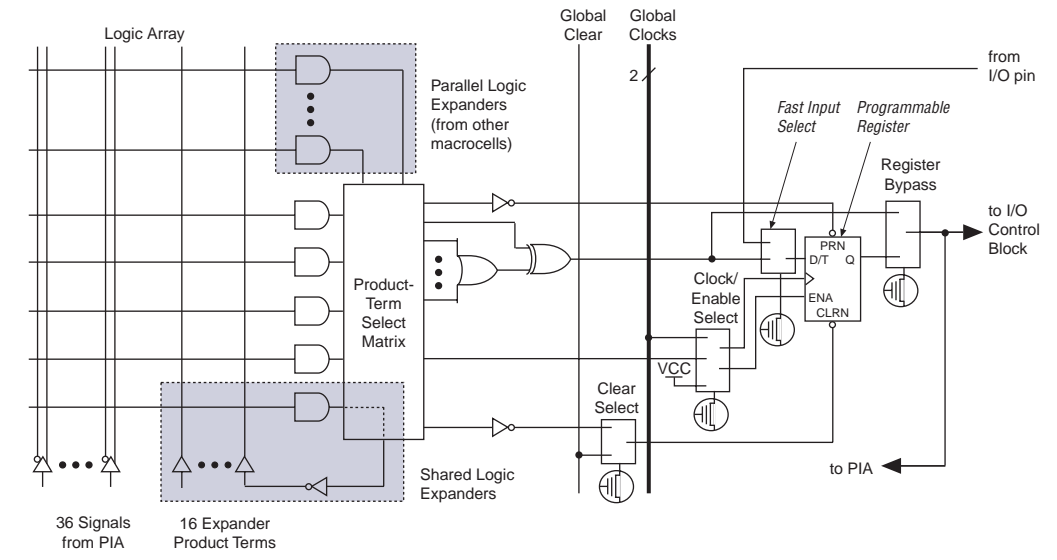
Functional Description

The MAX 7000 architecture includes the following elements:

- Logic array blocks
- Macrocells
- Expander product terms (shareable and parallel)
- Programmable interconnect array
- I/O control blocks

Figure 4 shows a MAX 7000E and MAX 7000S device macrocell.

Figure 4. MAX 7000E & MAX 7000S Device Macrocell



Combinatorial logic is implemented in the logic array, which provides five product terms per macrocell. The product-term select matrix allocates these product terms for use as either primary logic inputs (to the OR and XOR gates) to implement combinatorial functions, or as secondary inputs to the macrocell's register clear, preset, clock, and clock enable control functions. Two kinds of expander product terms ("expanders") are available to supplement macrocell logic resources:

- Shareable expanders, which are inverted product terms that are fed back into the logic array
- Parallel expanders, which are product terms borrowed from adjacent macrocells

The Altera development system automatically optimizes product-term allocation according to the logic requirements of the design.

For registered functions, each macrocell flipflop can be individually programmed to implement D, T, JK, or SR operation with programmable clock control. The flipflop can be bypassed for combinatorial operation. During design entry, the designer specifies the desired flipflop type; the Altera development software then selects the most efficient flipflop operation for each registered function to optimize resource utilization.

Each programmable register can be clocked in three different modes:

- By a global clock signal. This mode achieves the fastest clock-to-output performance.
- By a global clock signal and enabled by an active-high clock enable. This mode provides an enable on each flipflop while still achieving the fast clock-to-output performance of the global clock.
- By an array clock implemented with a product term. In this mode, the flipflop can be clocked by signals from buried macrocells or I/O pins.

In EPM7032, EPM7064, and EPM7096 devices, the global clock signal is available from a dedicated clock pin, GCLK1, as shown in [Figure 1](#). In MAX 7000E and MAX 7000S devices, two global clock signals are available. As shown in [Figure 2](#), these global clock signals can be the true or the complement of either of the global clock pins, GCLK1 or GCLK2.

Each register also supports asynchronous preset and clear functions. As shown in [Figures 3 and 4](#), the product-term select matrix allocates product terms to control these operations. Although the product-term-driven preset and clear of the register are active high, active-low control can be obtained by inverting the signal within the logic array. In addition, each register clear function can be individually driven by the active-low dedicated global clear pin (GCLRn). Upon power-up, each register in the device will be set to a low state.

All MAX 7000E and MAX 7000S I/O pins have a fast input path to a macrocell register. This dedicated path allows a signal to bypass the PIA and combinatorial logic and be driven to an input D flipflop with an extremely fast (2.5 ns) input setup time.

Expander Product Terms

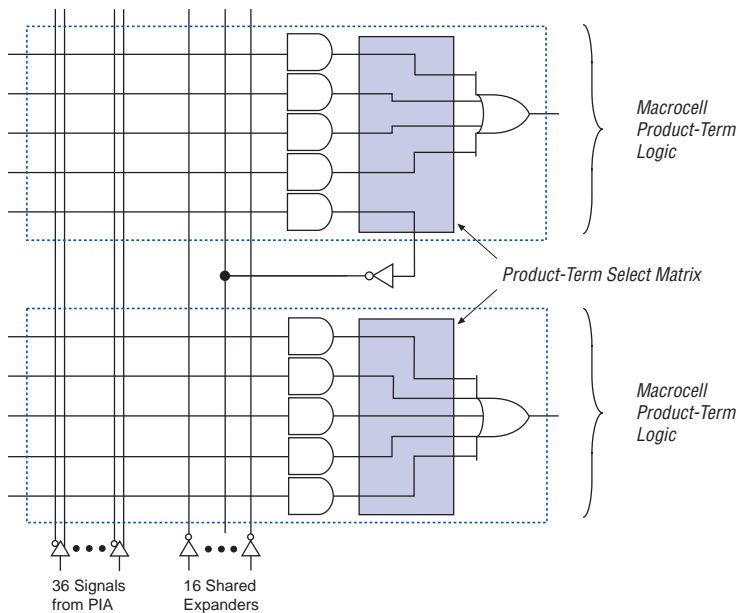
Although most logic functions can be implemented with the five product terms available in each macrocell, the more complex logic functions require additional product terms. Another macrocell can be used to supply the required logic resources; however, the MAX 7000 architecture also allows both shareable and parallel expander product terms (“expanders”) that provide additional product terms directly to any macrocell in the same LAB. These expanders help ensure that logic is synthesized with the fewest possible logic resources to obtain the fastest possible speed.

Shareable Expanders

Each LAB has 16 shareable expanders that can be viewed as a pool of uncommitted single product terms (one from each macrocell) with inverted outputs that feed back into the logic array. Each shareable expander can be used and shared by any or all macrocells in the LAB to build complex logic functions. A small delay (t_{SEXP}) is incurred when shareable expanders are used. Figure 5 shows how shareable expanders can feed multiple macrocells.

Figure 5. Shareable Expanders

Shareable expanders can be shared by any or all macrocells in an LAB.

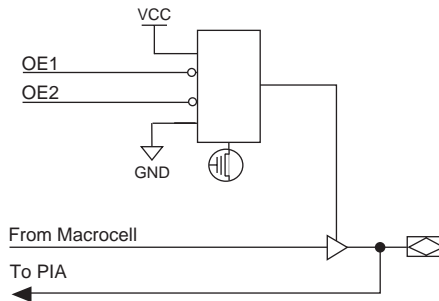


Parallel Expanders

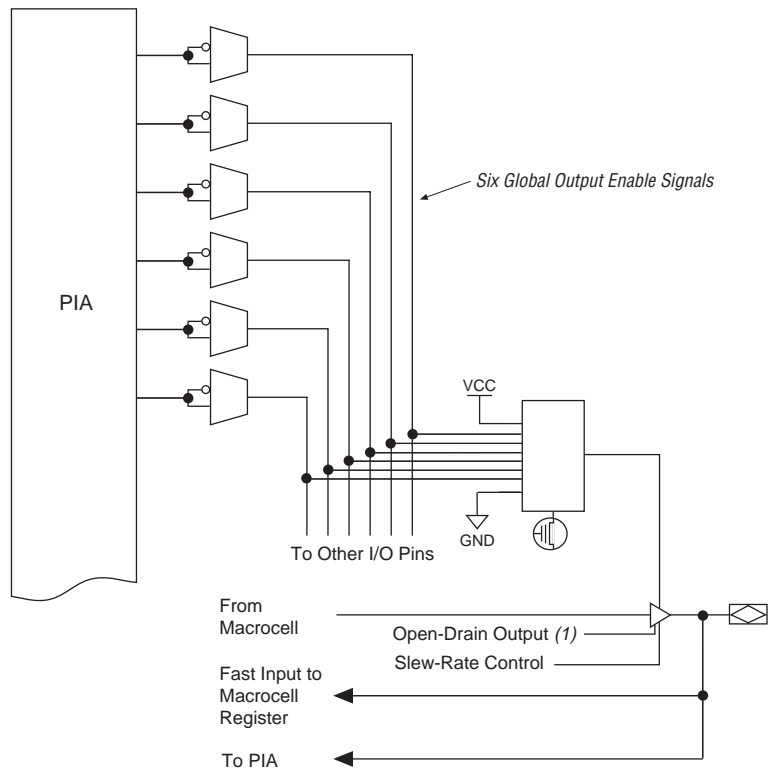
Parallel expanders are unused product terms that can be allocated to a neighboring macrocell to implement fast, complex logic functions. Parallel expanders allow up to 20 product terms to directly feed the macrocell OR logic, with five product terms provided by the macrocell and 15 parallel expanders provided by neighboring macrocells in the LAB.

Figure 8. I/O Control Block of MAX 7000 Devices

EPM7032, EPM7064 & EPM7096 Devices



MAX 7000E & MAX 7000S Devices



Note:

- (1) The open-drain output option is available only in MAX 7000S devices.

When the tri-state buffer control is connected to ground, the output is tri-stated (high impedance) and the I/O pin can be used as a dedicated input. When the tri-state buffer control is connected to V_{CC} , the output is enabled.

The MAX 7000 architecture provides dual I/O feedback, in which macrocell and pin feedbacks are independent. When an I/O pin is configured as an input, the associated macrocell can be used for buried logic.

In-System Programmability (ISP)

MAX 7000S devices are in-system programmable via an industry-standard 4-pin Joint Test Action Group (JTAG) interface (IEEE Std. 1149.1-1990). ISP allows quick, efficient iterations during design development and debugging cycles. The MAX 7000S architecture internally generates the high programming voltage required to program EEPROM cells, allowing in-system programming with only a single 5.0 V power supply. During in-system programming, the I/O pins are tri-stated and pulled-up to eliminate board conflicts. The pull-up value is nominally 50 k Ω .

ISP simplifies the manufacturing flow by allowing devices to be mounted on a printed circuit board with standard in-circuit test equipment before they are programmed. MAX 7000S devices can be programmed by downloading the information via in-circuit testers (ICT), embedded processors, or the Altera MasterBlaster, ByteBlasterMV, ByteBlaster, BitBlaster download cables. (The ByteBlaster cable is obsolete and is replaced by the ByteBlasterMV cable, which can program and configure 2.5-V, 3.3-V, and 5.0-V devices.) Programming the devices after they are placed on the board eliminates lead damage on high-pin-count packages (e.g., QFP packages) due to device handling and allows devices to be reprogrammed after a system has already shipped to the field. For example, product upgrades can be performed in the field via software or modem.

In-system programming can be accomplished with either an adaptive or constant algorithm. An adaptive algorithm reads information from the unit and adapts subsequent programming steps to achieve the fastest possible programming time for that unit. Because some in-circuit testers cannot support an adaptive algorithm, Altera offers devices tested with a constant algorithm. Devices tested to the constant algorithm have an "F" suffix in the ordering code.

The JamTM Standard Test and Programming Language (STAPL) can be used to program MAX 7000S devices with in-circuit testers, PCs, or embedded processor.



For more information on using the Jam language, refer to *AN 122: Using Jam STAPL for ISP & ICR via an Embedded Processor*.

The ISP circuitry in MAX 7000S devices is compatible with IEEE Std. 1532 specification. The IEEE Std. 1532 is a standard developed to allow concurrent ISP between multiple PLD vendors.

Programming Sequence

During in-system programming, instructions, addresses, and data are shifted into the MAX 7000S device through the TDI input pin. Data is shifted out through the TDO output pin and compared against the expected data.

Programming a pattern into the device requires the following six ISP stages. A stand-alone verification of a programmed pattern involves only stages 1, 2, 5, and 6.

1. *Enter ISP.* The enter ISP stage ensures that the I/O pins transition smoothly from user mode to ISP mode. The enter ISP stage requires 1 ms.
2. *Check ID.* Before any program or verify process, the silicon ID is checked. The time required to read this silicon ID is relatively small compared to the overall programming time.
3. *Bulk Erase.* Erasing the device in-system involves shifting in the instructions to erase the device and applying one erase pulse of 100 ms.
4. *Program.* Programming the device in-system involves shifting in the address and data and then applying the programming pulse to program the EEPROM cells. This process is repeated for each EEPROM address.
5. *Verify.* Verifying an Altera device in-system involves shifting in addresses, applying the read pulse to verify the EEPROM cells, and shifting out the data for comparison. This process is repeated for each EEPROM address.
6. *Exit ISP.* An exit ISP stage ensures that the I/O pins transition smoothly from ISP mode to user mode. The exit ISP stage requires 1 ms.

Table 15. MAX 7000 5.0-V Device DC Operating Conditions *Note (9)*

| Symbol | Parameter | Conditions | Min | Max | Unit |
|----------|--|--|------------------|-------------------|---------|
| V_{IH} | High-level input voltage | | 2.0 | $V_{CCINT} + 0.5$ | V |
| V_{IL} | Low-level input voltage | | -0.5 (8) | 0.8 | V |
| V_{OH} | 5.0-V high-level TTL output voltage | $I_{OH} = -4$ mA DC, $V_{CCIO} = 4.75$ V (10) | 2.4 | | V |
| | 3.3-V high-level TTL output voltage | $I_{OH} = -4$ mA DC, $V_{CCIO} = 3.00$ V (10) | 2.4 | | V |
| | 3.3-V high-level CMOS output voltage | $I_{OH} = -0.1$ mA DC, $V_{CCIO} = 3.0$ V (10) | $V_{CCIO} - 0.2$ | | V |
| V_{OL} | 5.0-V low-level TTL output voltage | $I_{OL} = 12$ mA DC, $V_{CCIO} = 4.75$ V (11) | | 0.45 | V |
| | 3.3-V low-level TTL output voltage | $I_{OL} = 12$ mA DC, $V_{CCIO} = 3.00$ V (11) | | 0.45 | V |
| | 3.3-V low-level CMOS output voltage | $I_{OL} = 0.1$ mA DC, $V_{CCIO} = 3.0$ V (11) | | 0.2 | V |
| I_I | Leakage current of dedicated input pins | $V_I = -0.5$ to 5.5 V (11) | -10 | 10 | μ A |
| I_{OZ} | I/O pin tri-state output off-state current | $V_I = -0.5$ to 5.5 V (11), (12) | -40 | 40 | μ A |

Table 16. MAX 7000 5.0-V Device Capacitance: EPM7032, EPM7064 & EPM7096 Devices *Note (13)*

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-----------------------|--------------------------------|-----|-----|------|
| C_{IN} | Input pin capacitance | $V_{IN} = 0$ V, $f = 1.0$ MHz | | 12 | pF |
| $C_{I/O}$ | I/O pin capacitance | $V_{OUT} = 0$ V, $f = 1.0$ MHz | | 12 | pF |

Table 17. MAX 7000 5.0-V Device Capacitance: MAX 7000E Devices *Note (13)*

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-----------------------|--------------------------------|-----|-----|------|
| C_{IN} | Input pin capacitance | $V_{IN} = 0$ V, $f = 1.0$ MHz | | 15 | pF |
| $C_{I/O}$ | I/O pin capacitance | $V_{OUT} = 0$ V, $f = 1.0$ MHz | | 15 | pF |

Table 18. MAX 7000 5.0-V Device Capacitance: MAX 7000S Devices *Note (13)*

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|---------------------------------|--------------------------------|-----|-----|------|
| C_{IN} | Dedicated input pin capacitance | $V_{IN} = 0$ V, $f = 1.0$ MHz | | 10 | pF |
| $C_{I/O}$ | I/O pin capacitance | $V_{OUT} = 0$ V, $f = 1.0$ MHz | | 10 | pF |

Table 23. MAX 7000 & MAX 7000E External Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | Unit |
|-------------------|--|----------------|------------------|------|-----------------------------------|------|------|
| | | | MAX 7000E (-12P) | | MAX 7000 (-12) MAX 7000E (-12) | | |
| | | | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 12.0 | | 12.0 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 12.0 | | 12.0 | ns |
| t _{SU} | Global clock setup time | | 7.0 | | 10.0 | | ns |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | (2) | 3.0 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | (2) | 0.0 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 6.0 | | 6.0 | ns |
| t _{CH} | Global clock high time | | 4.0 | | 4.0 | | ns |
| t _{CL} | Global clock low time | | 4.0 | | 4.0 | | ns |
| t _{ASU} | Array clock setup time | | 3.0 | | 4.0 | | ns |
| t _{AH} | Array clock hold time | | 4.0 | | 4.0 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 12.0 | | 12.0 | ns |
| t _{ACH} | Array clock high time | | 5.0 | | 5.0 | | ns |
| t _{ACL} | Array clock low time | | 5.0 | | 5.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 5.0 | | 5.0 | | ns |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (4) | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 11.0 | | 11.0 | ns |
| f _{CNT} | Maximum internal global clock frequency | (5) | 90.9 | | 90.9 | | MHz |
| t _{ACNT} | Minimum array clock period | | | 11.0 | | 11.0 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (5) | 90.9 | | 90.9 | | MHz |
| f _{MAX} | Maximum clock frequency | (6) | 125.0 | | 125.0 | | MHz |

Table 25. MAX 7000 & MAX 7000E External Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|-------------------|--|----------------|-------------|------|------|------|------|------|------|
| | | | -15 | | -15T | | -20 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 15.0 | | 15.0 | | 20.0 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 15.0 | | 15.0 | | 20.0 | ns |
| t _{SU} | Global clock setup time | | 11.0 | | 11.0 | | 12.0 | | ns |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | (2) | 3.0 | | – | | 5.0 | | ns |
| t _{FH} | Global clock hold time of fast input | (2) | 0.0 | | – | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 8.0 | | 8.0 | | 12.0 | ns |
| t _{CH} | Global clock high time | | 5.0 | | 6.0 | | 6.0 | | ns |
| t _{CL} | Global clock low time | | 5.0 | | 6.0 | | 6.0 | | ns |
| t _{ASU} | Array clock setup time | | 4.0 | | 4.0 | | 5.0 | | ns |
| t _{AH} | Array clock hold time | | 4.0 | | 4.0 | | 5.0 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 15.0 | | 15.0 | | 20.0 | ns |
| t _{ACH} | Array clock high time | | 6.0 | | 6.5 | | 8.0 | | ns |
| t _{ACL} | Array clock low time | | 6.0 | | 6.5 | | 8.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 6.0 | | 6.5 | | 8.0 | | ns |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (4) | 1.0 | | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 13.0 | | 13.0 | | 16.0 | ns |
| f _{CNT} | Maximum internal global clock frequency | (5) | 76.9 | | 76.9 | | 62.5 | | MHz |
| t _{ACNT} | Minimum array clock period | | | 13.0 | | 13.0 | | 16.0 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (5) | 76.9 | | 76.9 | | 62.5 | | MHz |
| f _{MAX} | Maximum clock frequency | (6) | 100 | | 83.3 | | 83.3 | | MHz |

Table 27. EPM7032S External Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
|-------------------|--|------------|-------------|-----|-------|-----|-------|-----|-------|-----|------|
| | | | -5 | | -6 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| f _{ACNT} | Maximum internal array clock frequency | (4) | 175.4 | | 142.9 | | 116.3 | | 100.0 | | MHz |
| f _{MAX} | Maximum clock frequency | (5) | 250.0 | | 200.0 | | 166.7 | | 125.0 | | MHz |

Table 28. EPM7032S Internal Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
|------------|-----------------------------------|----------------|-------------|-----|-----|-----|-----|-----|-----|-----|------|
| | | | -5 | | -6 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t_{IN} | Input pad and buffer delay | | | 0.2 | | 0.2 | | 0.3 | | 0.5 | ns |
| t_{IO} | I/O input pad and buffer delay | | | 0.2 | | 0.2 | | 0.3 | | 0.5 | ns |
| t_{FIN} | Fast input delay | | | 2.2 | | 2.1 | | 2.5 | | 1.0 | ns |
| t_{SEXP} | Shared expander delay | | | 3.1 | | 3.8 | | 4.6 | | 5.0 | ns |
| t_{PEXP} | Parallel expander delay | | | 0.9 | | 1.1 | | 1.4 | | 0.8 | ns |
| t_{LAD} | Logic array delay | | | 2.6 | | 3.3 | | 4.0 | | 5.0 | ns |
| t_{LAC} | Logic control array delay | | | 2.5 | | 3.3 | | 4.0 | | 5.0 | ns |
| t_{IOE} | Internal output enable delay | | | 0.7 | | 0.8 | | 1.0 | | 2.0 | ns |
| t_{OD1} | Output buffer and pad delay | C1 = 35 pF | | 0.2 | | 0.3 | | 0.4 | | 1.5 | ns |
| t_{OD2} | Output buffer and pad delay | C1 = 35 pF (6) | | 0.7 | | 0.8 | | 0.9 | | 2.0 | ns |
| t_{OD3} | Output buffer and pad delay | C1 = 35 pF | | 5.2 | | 5.3 | | 5.4 | | 5.5 | ns |
| t_{ZX1} | Output buffer enable delay | C1 = 35 pF | | 4.0 | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{ZX2} | Output buffer enable delay | C1 = 35 pF (6) | | 4.5 | | 4.5 | | 4.5 | | 5.5 | ns |
| t_{ZX3} | Output buffer enable delay | C1 = 35 pF | | 9.0 | | 9.0 | | 9.0 | | 9.0 | ns |
| t_{XZ} | Output buffer disable delay | C1 = 5 pF | | 4.0 | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{SU} | Register setup time | | 0.8 | | 1.0 | | 1.3 | | 2.0 | | ns |
| t_H | Register hold time | | 1.7 | | 2.0 | | 2.5 | | 3.0 | | ns |
| t_{FSU} | Register setup time of fast input | | 1.9 | | 1.8 | | 1.7 | | 3.0 | | ns |
| t_{FH} | Register hold time of fast input | | 0.6 | | 0.7 | | 0.8 | | 0.5 | | ns |
| t_{RD} | Register delay | | | 1.2 | | 1.6 | | 1.9 | | 2.0 | ns |
| t_{COMB} | Combinatorial delay | | | 0.9 | | 1.1 | | 1.4 | | 2.0 | ns |
| t_{IC} | Array clock delay | | | 2.7 | | 3.4 | | 4.2 | | 5.0 | ns |
| t_{EN} | Register enable time | | | 2.6 | | 3.3 | | 4.0 | | 5.0 | ns |
| t_{GLOB} | Global control delay | | | 1.6 | | 1.4 | | 1.7 | | 1.0 | ns |
| t_{PRE} | Register preset time | | | 2.0 | | 2.4 | | 3.0 | | 3.0 | ns |
| t_{CLR} | Register clear time | | | 2.0 | | 2.4 | | 3.0 | | 3.0 | ns |

Table 29. EPM7064S External Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
|-------------------|--|----------------|-------------|-----|-------|-----|-------|-----|-------|------|------|
| | | | -5 | | -6 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 5.4 | | 6.7 | | 7.5 | | 10.0 | ns |
| t _{ACH} | Array clock high time | | 2.5 | | 2.5 | | 3.0 | | 4.0 | | ns |
| t _{ACL} | Array clock low time | | 2.5 | | 2.5 | | 3.0 | | 4.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (2) | 2.5 | | 2.5 | | 3.0 | | 4.0 | | ns |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (3) | 1.0 | | 1.0 | | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 5.7 | | 7.1 | | 8.0 | | 10.0 | ns |
| f _{CNT} | Maximum internal global clock frequency | (4) | 175.4 | | 140.8 | | 125.0 | | 100.0 | | MHz |
| t _{ACNT} | Minimum array clock period | | | 5.7 | | 7.1 | | 8.0 | | 10.0 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (4) | 175.4 | | 140.8 | | 125.0 | | 100.0 | | MHz |
| f _{MAX} | Maximum clock frequency | (5) | 250.0 | | 200.0 | | 166.7 | | 125.0 | | MHz |

Table 30. EPM7064S Internal Timing Parameters (Part 1 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
|------------|--------------------------------|----------------|-------------|-----|-----|-----|-----|-----|-----|-----|------|
| | | | -5 | | -6 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t_{IN} | Input pad and buffer delay | | | 0.2 | | 0.2 | | 0.5 | | 0.5 | ns |
| t_{IO} | I/O input pad and buffer delay | | | 0.2 | | 0.2 | | 0.5 | | 0.5 | ns |
| t_{FIN} | Fast input delay | | | 2.2 | | 2.6 | | 1.0 | | 1.0 | ns |
| t_{SEXP} | Shared expander delay | | | 3.1 | | 3.8 | | 4.0 | | 5.0 | ns |
| t_{PEXP} | Parallel expander delay | | | 0.9 | | 1.1 | | 0.8 | | 0.8 | ns |
| t_{LAD} | Logic array delay | | | 2.6 | | 3.2 | | 3.0 | | 5.0 | ns |
| t_{LAC} | Logic control array delay | | | 2.5 | | 3.2 | | 3.0 | | 5.0 | ns |
| t_{IOE} | Internal output enable delay | | | 0.7 | | 0.8 | | 2.0 | | 2.0 | ns |
| t_{OD1} | Output buffer and pad delay | C1 = 35 pF | | 0.2 | | 0.3 | | 2.0 | | 1.5 | ns |
| t_{OD2} | Output buffer and pad delay | C1 = 35 pF (6) | | 0.7 | | 0.8 | | 2.5 | | 2.0 | ns |
| t_{OD3} | Output buffer and pad delay | C1 = 35 pF | | 5.2 | | 5.3 | | 7.0 | | 5.5 | ns |
| t_{ZX1} | Output buffer enable delay | C1 = 35 pF | | 4.0 | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{ZX2} | Output buffer enable delay | C1 = 35 pF (6) | | 4.5 | | 4.5 | | 4.5 | | 5.5 | ns |
| t_{ZX3} | Output buffer enable delay | C1 = 35 pF | | 9.0 | | 9.0 | | 9.0 | | 9.0 | ns |
| t_{XZ} | Output buffer disable delay | C1 = 5 pF | | 4.0 | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{SU} | Register setup time | | 0.8 | | 1.0 | | 3.0 | | 2.0 | | ns |
| t_H | Register hold time | | 1.7 | | 2.0 | | 2.0 | | 3.0 | | ns |

Table 30. EPM7064S Internal Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
|------------|-----------------------------------|------------|-------------|------|-----|------|-----|------|-----|------|------|
| | | | -5 | | -6 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t_{FSU} | Register setup time of fast input | | 1.9 | | 1.8 | | 3.0 | | 3.0 | | ns |
| t_{FH} | Register hold time of fast input | | 0.6 | | 0.7 | | 0.5 | | 0.5 | | ns |
| t_{RD} | Register delay | | | 1.2 | | 1.6 | | 1.0 | | 2.0 | ns |
| t_{COMB} | Combinatorial delay | | | 0.9 | | 1.0 | | 1.0 | | 2.0 | ns |
| t_{IC} | Array clock delay | | | 2.7 | | 3.3 | | 3.0 | | 5.0 | ns |
| t_{EN} | Register enable time | | | 2.6 | | 3.2 | | 3.0 | | 5.0 | ns |
| t_{GLOB} | Global control delay | | | 1.6 | | 1.9 | | 1.0 | | 1.0 | ns |
| t_{PRE} | Register preset time | | | 2.0 | | 2.4 | | 2.0 | | 3.0 | ns |
| t_{CLR} | Register clear time | | | 2.0 | | 2.4 | | 2.0 | | 3.0 | ns |
| t_{PIA} | PIA delay | (7) | | 1.1 | | 1.3 | | 1.0 | | 1.0 | ns |
| t_{LPA} | Low-power adder | (8) | | 12.0 | | 11.0 | | 10.0 | | 11.0 | ns |

Notes to tables:

- (1) These values are specified under the recommended operating conditions shown in Table 14. See Figure 13 for more information on switching waveforms.
- (2) This minimum pulse width for preset and clear applies for both global clear and array controls. The t_{LPA} parameter must be added to this minimum width if the clear or reset signal incorporates the t_{LAD} parameter into the signal path.
- (3) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies for both global and array clocking.
- (4) These parameters are measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (5) The f_{MAX} values represent the highest frequency for pipelined data.
- (6) Operating conditions: $V_{CCIO} = 3.3\text{ V} \pm 10\%$ for commercial and industrial use.
- (7) For EPM7064S-5, EPM7064S-6, EPM7128S-6, EPM7160S-6, EPM7160S-7, EPM7192S-7, and EPM7256S-7 devices, these values are specified for a PIA fan-out of one LAB (16 macrocells). For each additional LAB fan-out in these devices, add an additional 0.1 ns to the PIA timing value.
- (8) The t_{LPA} parameter must be added to the t_{LAD} , t_{LAC} , t_{IC} , t_{EN} , t_{SEXP} , t_{ACL} and t_{CPPW} parameters for macrocells running in the low-power mode.

Table 35. EPM7192S External Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|-------------------|--|----------------|-------------|-----|-------|------|-------|------|------|
| | | | -7 | | -10 | | -15 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t _{AH} | Array clock hold time | | 1.8 | | 3.0 | | 4.0 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 7.8 | | 10.0 | | 15.0 | ns |
| t _{ACH} | Array clock high time | | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{ACL} | Array clock low time | | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (2) | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (3) | 1.0 | | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 8.0 | | 10.0 | | 13.0 | ns |
| f _{CNT} | Maximum internal global clock frequency | (4) | 125.0 | | 100.0 | | 76.9 | | MHz |
| t _{ACNT} | Minimum array clock period | | | 8.0 | | 10.0 | | 13.0 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (4) | 125.0 | | 100.0 | | 76.9 | | MHz |
| f _{MAX} | Maximum clock frequency | (5) | 166.7 | | 125.0 | | 100.0 | | MHz |

Table 36. EPM7192S Internal Timing Parameters (Part 1 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|------------|--------------------------------|----------------|-------------|-----|-----|-----|-----|------|------|
| | | | -7 | | -10 | | -15 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t_{IN} | Input pad and buffer delay | | | 0.3 | | 0.5 | | 2.0 | ns |
| t_{IO} | I/O input pad and buffer delay | | | 0.3 | | 0.5 | | 2.0 | ns |
| t_{FIN} | Fast input delay | | | 3.2 | | 1.0 | | 2.0 | ns |
| t_{SEXP} | Shared expander delay | | | 4.2 | | 5.0 | | 8.0 | ns |
| t_{PEXP} | Parallel expander delay | | | 1.2 | | 0.8 | | 1.0 | ns |
| t_{LAD} | Logic array delay | | | 3.1 | | 5.0 | | 6.0 | ns |
| t_{LAC} | Logic control array delay | | | 3.1 | | 5.0 | | 6.0 | ns |
| t_{IOE} | Internal output enable delay | | | 0.9 | | 2.0 | | 3.0 | ns |
| t_{OD1} | Output buffer and pad delay | C1 = 35 pF | | 0.5 | | 1.5 | | 4.0 | ns |
| t_{OD2} | Output buffer and pad delay | C1 = 35 pF (6) | | 1.0 | | 2.0 | | 5.0 | ns |
| t_{OD3} | Output buffer and pad delay | C1 = 35 pF | | 5.5 | | 5.5 | | 7.0 | ns |
| t_{ZX1} | Output buffer enable delay | C1 = 35 pF | | 4.0 | | 5.0 | | 6.0 | ns |
| t_{ZX2} | Output buffer enable delay | C1 = 35 pF (6) | | 4.5 | | 5.5 | | 7.0 | ns |
| t_{ZX3} | Output buffer enable delay | C1 = 35 pF | | 9.0 | | 9.0 | | 10.0 | ns |
| t_{XZ} | Output buffer disable delay | C1 = 5 pF | | 4.0 | | 5.0 | | 6.0 | ns |
| t_{SU} | Register setup time | | 1.1 | | 2.0 | | 4.0 | | ns |

Table 36. EPM7192S Internal Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|------------|-----------------------------------|------------|-------------|------|-----|------|-----|------|------|
| | | | -7 | | -10 | | -15 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t_H | Register hold time | | 1.7 | | 3.0 | | 4.0 | | ns |
| t_{FSU} | Register setup time of fast input | | 2.3 | | 3.0 | | 2.0 | | ns |
| t_{FH} | Register hold time of fast input | | 0.7 | | 0.5 | | 1.0 | | ns |
| t_{RD} | Register delay | | | 1.4 | | 2.0 | | 1.0 | ns |
| t_{COMB} | Combinatorial delay | | | 1.2 | | 2.0 | | 1.0 | ns |
| t_{IC} | Array clock delay | | | 3.2 | | 5.0 | | 6.0 | ns |
| t_{EN} | Register enable time | | | 3.1 | | 5.0 | | 6.0 | ns |
| t_{GLOB} | Global control delay | | | 2.5 | | 1.0 | | 1.0 | ns |
| t_{PRE} | Register preset time | | | 2.7 | | 3.0 | | 4.0 | ns |
| t_{CLR} | Register clear time | | | 2.7 | | 3.0 | | 4.0 | ns |
| t_{PIA} | PIA delay | (7) | | 2.4 | | 1.0 | | 2.0 | ns |
| t_{LPA} | Low-power adder | (8) | | 10.0 | | 11.0 | | 13.0 | ns |

Notes to tables:

- (1) These values are specified under the recommended operating conditions shown in Table 14. See Figure 13 for more information on switching waveforms.
- (2) This minimum pulse width for preset and clear applies for both global clear and array controls. The t_{LPA} parameter must be added to this minimum width if the clear or reset signal incorporates the t_{LAD} parameter into the signal path.
- (3) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies for both global and array clocking.
- (4) These parameters are measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (5) The f_{MAX} values represent the highest frequency for pipelined data.
- (6) Operating conditions: $V_{CCIO} = 3.3\text{ V} \pm 10\%$ for commercial and industrial use.
- (7) For EPM7064S-5, EPM7064S-6, EPM7128S-6, EPM7160S-6, EPM7160S-7, EPM7192S-7, and EPM7256S-7 devices, these values are specified for a PIA fan-out of one LAB (16 macrocells). For each additional LAB fan-out in these devices, add an additional 0.1 ns to the PIA timing value.
- (8) The t_{LPA} parameter must be added to the t_{LAD} , t_{LAC} , t_{IC} , t_{EN} , t_{SEXP} , t_{ACL} and t_{CPW} parameters for macrocells running in the low-power mode.

Table 38. EPM7256S Internal Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|------------|-----------------------------------|----------------|-------------|------|-----|------|-----|------|------|
| | | | -7 | | -10 | | -15 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t_{IN} | Input pad and buffer delay | | | 0.3 | | 0.5 | | 2.0 | ns |
| t_{IO} | I/O input pad and buffer delay | | | 0.3 | | 0.5 | | 2.0 | ns |
| t_{FIN} | Fast input delay | | | 3.4 | | 1.0 | | 2.0 | ns |
| t_{SEXP} | Shared expander delay | | | 3.9 | | 5.0 | | 8.0 | ns |
| t_{PEXP} | Parallel expander delay | | | 1.1 | | 0.8 | | 1.0 | ns |
| t_{LAD} | Logic array delay | | | 2.6 | | 5.0 | | 6.0 | ns |
| t_{LAC} | Logic control array delay | | | 2.6 | | 5.0 | | 6.0 | ns |
| t_{IOE} | Internal output enable delay | | | 0.8 | | 2.0 | | 3.0 | ns |
| t_{OD1} | Output buffer and pad delay | C1 = 35 pF | | 0.5 | | 1.5 | | 4.0 | ns |
| t_{OD2} | Output buffer and pad delay | C1 = 35 pF (6) | | 1.0 | | 2.0 | | 5.0 | ns |
| t_{OD3} | Output buffer and pad delay | C1 = 35 pF | | 5.5 | | 5.5 | | 8.0 | ns |
| t_{ZX1} | Output buffer enable delay | C1 = 35 pF | | 4.0 | | 5.0 | | 6.0 | ns |
| t_{ZX2} | Output buffer enable delay | C1 = 35 pF (6) | | 4.5 | | 5.5 | | 7.0 | ns |
| t_{ZX3} | Output buffer enable delay | C1 = 35 pF | | 9.0 | | 9.0 | | 10.0 | ns |
| t_{XZ} | Output buffer disable delay | C1 = 5 pF | | 4.0 | | 5.0 | | 6.0 | ns |
| t_{SU} | Register setup time | | 1.1 | | 2.0 | | 4.0 | | ns |
| t_H | Register hold time | | 1.6 | | 3.0 | | 4.0 | | ns |
| t_{FSU} | Register setup time of fast input | | 2.4 | | 3.0 | | 2.0 | | ns |
| t_{FH} | Register hold time of fast input | | 0.6 | | 0.5 | | 1.0 | | ns |
| t_{RD} | Register delay | | | 1.1 | | 2.0 | | 1.0 | ns |
| t_{COMB} | Combinatorial delay | | | 1.1 | | 2.0 | | 1.0 | ns |
| t_{IC} | Array clock delay | | | 2.9 | | 5.0 | | 6.0 | ns |
| t_{EN} | Register enable time | | | 2.6 | | 5.0 | | 6.0 | ns |
| t_{GLOB} | Global control delay | | | 2.8 | | 1.0 | | 1.0 | ns |
| t_{PRE} | Register preset time | | | 2.7 | | 3.0 | | 4.0 | ns |
| t_{CLR} | Register clear time | | | 2.7 | | 3.0 | | 4.0 | ns |
| t_{PIA} | PIA delay | (7) | | 3.0 | | 1.0 | | 2.0 | ns |
| t_{LPA} | Low-power adder | (8) | | 10.0 | | 11.0 | | 13.0 | ns |

Notes to tables:

- (1) These values are specified under the recommended operating conditions shown in [Table 14](#). See [Figure 13](#) for more information on switching waveforms.
- (2) This minimum pulse width for preset and clear applies for both global clear and array controls. The t_{LPA} parameter must be added to this minimum width if the clear or reset signal incorporates the t_{LAD} parameter into the signal path.
- (3) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies for both global and array clocking.
- (4) These parameters are measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (5) The f_{MAX} values represent the highest frequency for pipelined data.
- (6) Operating conditions: $V_{CCIO} = 3.3 \text{ V} \pm 10\%$ for commercial and industrial use.
- (7) For EPM7064S-5, EPM7064S-6, EPM7128S-6, EPM7160S-6, EPM7160S-7, EPM7192S-7, and EPM7256S-7 devices, these values are specified for a PIA fan-out of one LAB (16 macrocells). For each additional LAB fan-out in these devices, add an additional 0.1 ns to the PIA timing value.
- (8) The t_{LPA} parameter must be added to the t_{LAD} , t_{LAC} , t_{IC} , t_{EN} , t_{SEXP} , t_{ACL} , and t_{CPTW} parameters for macrocells running in the low-power mode.

Power Consumption

Supply power (P) versus frequency (f_{MAX} in MHz) for MAX 7000 devices is calculated with the following equation:

$$P = P_{INT} + P_{IO} = I_{CCINT} \times V_{CC} + P_{IO}$$

The P_{IO} value, which depends on the device output load characteristics and switching frequency, can be calculated using the guidelines given in [Application Note 74 \(Evaluating Power for Altera Devices\)](#).

The I_{CCINT} value, which depends on the switching frequency and the application logic, is calculated with the following equation:

$$I_{CCINT} =$$

$$A \times MC_{TON} + B \times (MC_{DEV} - MC_{TON}) + C \times MC_{USED} \times f_{MAX} \times \text{tog}_{LC}$$

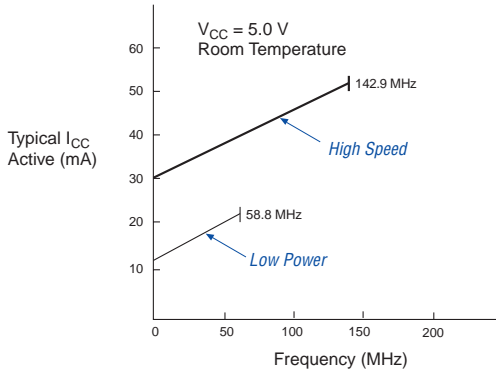
The parameters in this equation are shown below:

| | | |
|-------------------|---|---|
| MC_{TON} | = | Number of macrocells with the Turbo Bit option turned on, as reported in the MAX+PLUS II Report File (.rpt) |
| MC_{DEV} | = | Number of macrocells in the device |
| MC_{USED} | = | Total number of macrocells in the design, as reported in the MAX+PLUS II Report File (.rpt) |
| f_{MAX} | = | Highest clock frequency to the device |
| tog_{LC} | = | Average ratio of logic cells toggling at each clock (typically 0.125) |
| A, B, C | = | Constants, shown in Table 39 |

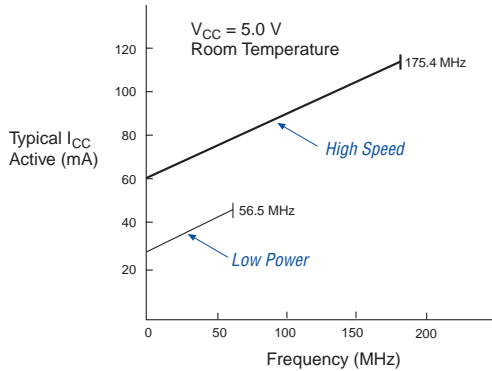
Figure 15 shows typical supply current versus frequency for MAX 7000S devices.

Figure 15. I_{CC} vs. Frequency for MAX 7000S Devices (Part 1 of 2)

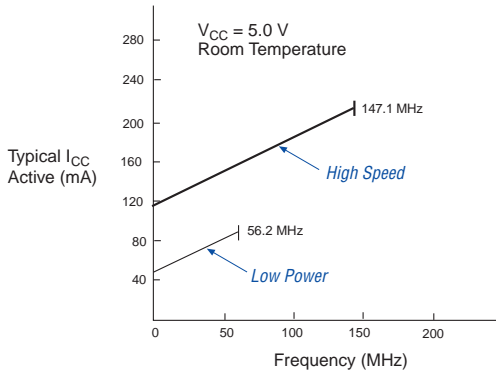
EPM7032S



EPM7064S



EPM7128S



EPM7160S

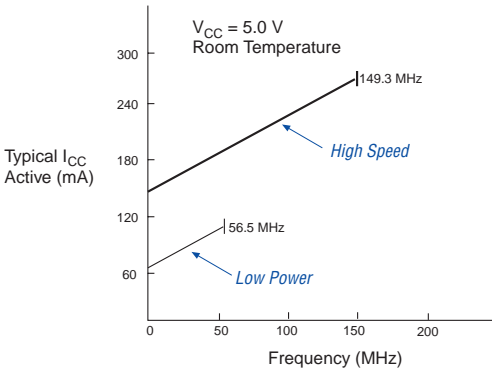
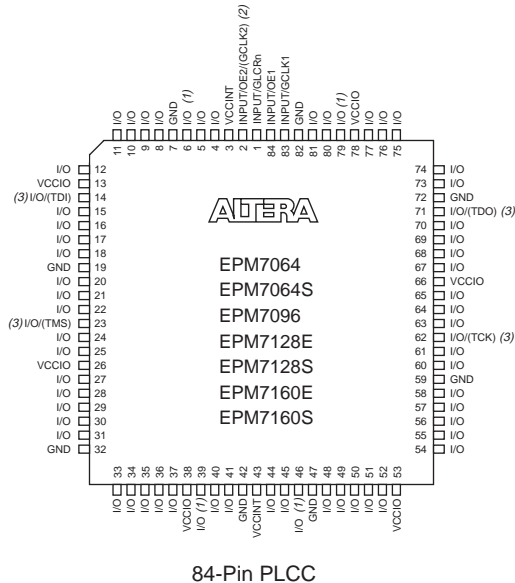


Figure 18. 84-Pin Package Pin-Out Diagram

Package outline not drawn to scale.



Notes:

- (1) Pins 6, 39, 46, and 79 are no-connect (N.C.) pins on EPM7096, EPM7160E, and EPM7160S devices.
- (2) The pin functions shown in parenthesis are only available in MAX 7000E and MAX 7000S devices.
- (3) JTAG ports are available in MAX 7000S devices only.

Figure 19. 100-Pin Package Pin-Out Diagram

Package outline not drawn to scale.

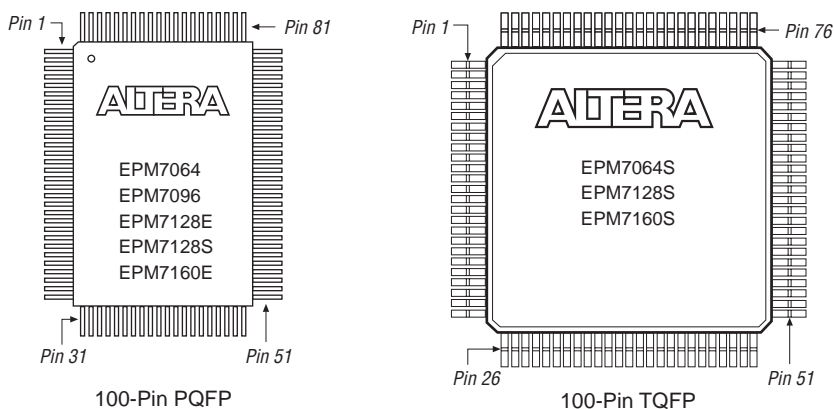


Figure 20. 160-Pin Package Pin-Out Diagram

Package outline not drawn to scale.

